Vishay Siliconix

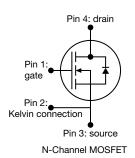
COMPLIANT

HALOGEN

FREE

E Series Power MOSFET





PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	650		
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.059	
Q _g max. (nC)	80		
Q _{gs} (nC)	17		
Q _{gd} (nC)	20		
Configuration	Single		

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) R_{on} x Q_g
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH068N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage	V _{DS}	600	V		
Gate-source voltage	V _{GS}	± 30	V		
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 25^{\circ}$	C ,	34		
	$T_C = 100^{\circ}$	C I _D	22	Α	
Pulsed drain current ^a	I _{DM}	100			
Linear derating factor			1.6	W/°C	
Single pulse avalanche energy b		E _{AS}	226	mJ	
Maximum power dissipation		P _D	202	W	
Operating junction and storage temperature rang	e	T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °	C dv/dt 70		V/ns	
Reverse diode dv/dt ^c		dv/dt	50	V/IIS	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.0 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R_{thJA}	38	50	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	0.48	0.62	C/VV	

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							•
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.56	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Oak as a salad as	I _{GSS}	,	$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Gate-source leakage		,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zana mata walta sa aluaisa awanant		V _{DS} =	600 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 15 A	-	0.059	0.068	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	V _{DS} = 20 V, I _D = 15 A		9.3	-	S
Dynamic		•		•			
Input capacitance	C _{iss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		2650	-	
Output capacitance	C _{oss}	,			113	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	6	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V 0V 400 V V 0V		-	94	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		591	-	
Total gate charge	Qg			-	53	80	nC
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V	-	17	-	
Gate-drain charge	Q _{gd}				20	-	1
Turn-on delay time	t _{d(on)}		V _{DD} = 480 V, I _D = 15 A,		56	84	
Rise time	t _r	V _{DD} =			148	222	
Turn-off delay time	t _{d(off)}		$= 10 \text{ V}, R_g = 9.1 \Omega$	-	60	90	ns
Fall time	t _f	1		-	30	60	
Gate input resistance	R_g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	34	
Pulsed diode forward current	I _{SM}			-	-	100	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 15 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	377	754	ns
Reverse recovery charge	Q _{rr}			-	5.7	11.4	μC
Reverse recovery current	I _{RRM}			_	25	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

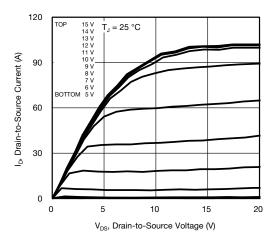


Fig. 1 - Typical Output Characteristics

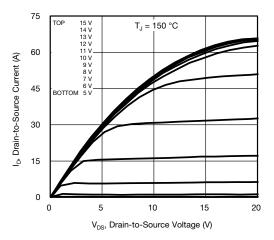


Fig. 2 - Typical Output Characteristics

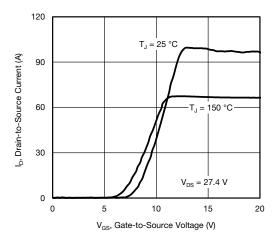


Fig. 3 - Typical Transfer Characteristics

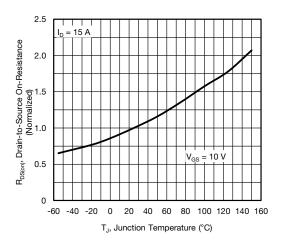


Fig. 4 - Normalized On-Resistance vs. Temperature

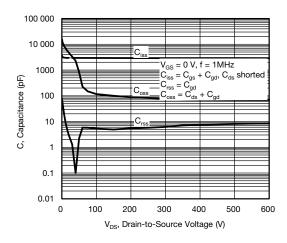


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

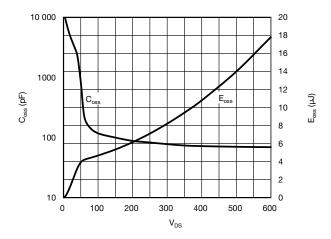


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



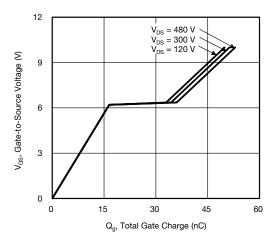


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

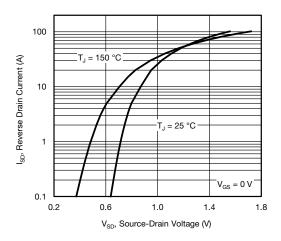


Fig. 8 - Typical Source-Drain Diode Forward Voltage

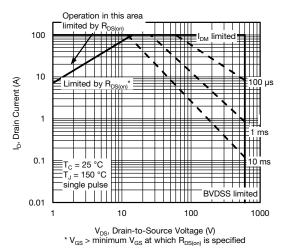


Fig. 9 - Maximum Safe Operating Area

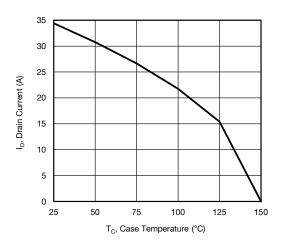


Fig. 10 - Maximum Drain Current vs. Case Temperature

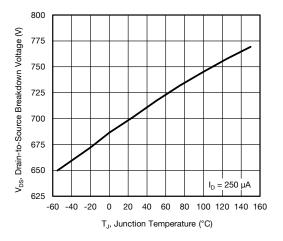


Fig. 11 - Temperature vs. Drain-to-Source Voltage



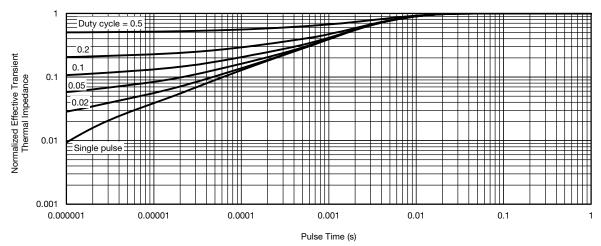


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

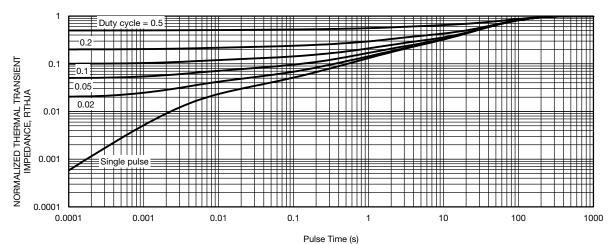


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

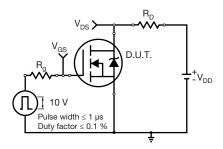


Fig. 14 - Switching Time Test Circuit

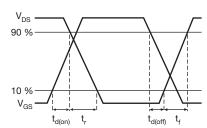


Fig. 15 - Switching Time Waveforms

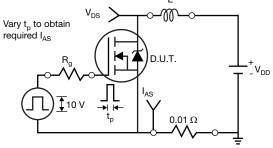


Fig. 16 - Unclamped Inductive Test Circuit

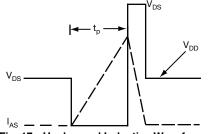


Fig. 17 - Unclamped Inductive Waveforms



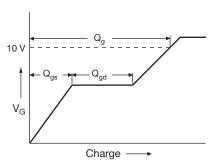


Fig. 18 - Basic Gate Charge Waveform

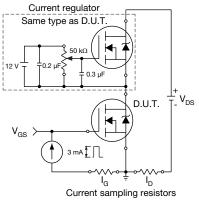
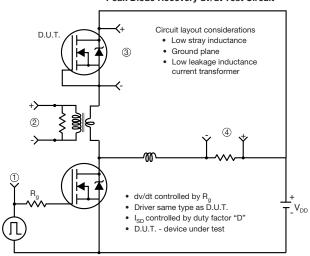


Fig. 19 - Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



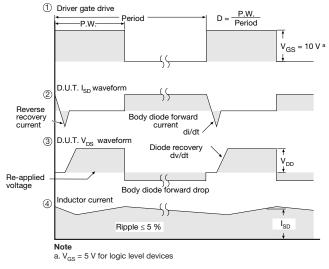


Fig. 20 - For N-Channel

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